General Purpose Metallized Polyester Film Capacitors R66, Radial, 7.5 mm Lead Spacing, 50 – 630 VDC (Automotive Grade)



Overview

The R66 is constructed of metallized polyester film (wound or stacked technology) with radial leads of tinned wire. Radial leads are electrically welded to the contact metal layer on the ends of the capacitor winding. The capacitor is encapsulated with thermosetting resin in a box of material meeting the UL 94V-0 requirements.

Automotive grade devices meet the demanding Automotive Electronics Council's AEC-Q200 qualification requirements.

Applications

Typical applications include blocking, coupling, decoupling, bypassing and interference suppression in low voltage applications such as automotive. Not suitable for acrossthe-line application (see suppressor capacitors).

Benefits

- Voltage range: 50 630 VDC
- Capacitance range: 0.001 4.7 μF
- Lead Spacing: 7.5 mm
- Capacitance tolerance: ±5%, ±10%, ±20%
- Climatic category: 55/105/56
- Operating temperature range of -55°C to +105°C
- · RoHS compliance and lead (Pb)-free terminations
- Tape and reel packaging in accordance with IEC 60286-2
- Self-healing
- Automotive grade (AEC-Q200)

Part Number System

R66	E	D	3100	AA	7A	J
Series	Rated Voltage (VDC)	Length (mm)	Capacitance Code (pF)	Packaging	Internal Use	Capacitance Tolerance
Metallized Polyester	C = 50 D = 63 E = 100 I = 250 M = 400 P = 630	D = 7.5	The last three digits represent significant figures. First digit specifies the number of zeros to be added.	See Ordering Options Table	10 6A 7A	J = ±5% K = ±10% M = ±20%





Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	LL Lead Length (mm)	Lead and Packaging Code
	Standard Lead and Packaging Options		
	Bulk (Bag) – short leads	4 +2/-0	AA
	Ammo pack	H ₀ =18.5 ±0.5	DQ
	Other Lead and Packaging Options		
7.5	Tape & Reel (Standard reel Ø 355 mm)	H ₀ = 18.5 ±0.5	СК
	Bulk (Bag) – short leads	2.7 +0.5/-0	JA
	Bulk (Bag) – short leads	3.5 +0.5/-0	JB
	Bulk (Bag) – short leads	10 ±1	JC
	Bulk (Bag) – short leads	3.2 +0.3/-0.2	JH
	Bulk (Bag) – long leads	17 +1/-2	Z3

Dimensions – Millimeters



I	D		В		Н		L		d	
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	
7.5	±0.4	3.0	+0.1	8.0	+0.1	10.0	+0.2	0.5	±0.05	
7.5	±0.4	4.0	+0.1	9.0	+0.1	10.0	+0.2	0.6	±0.05	
7.5	±0.4	5.0	+0.1	10.5	+0.1	10.0	+0.2	0.6	±0.05	
7.5	±0.4	6.0	+0.1	12.0	+0.1	10.5	+0.2	0.6	±0.05	
	Note: See Ordering Options Table for lead length (LL/H ₀) options.									



Performance Characteristics

Dielectric	Polyester film (polyethylene terephthalate)							
Plates	Metal layer deposited by evaporation under vacuum							
Winding	Non-inductive type							
Leads	Tinned wire							
Protection	Plastic case, thermosetting resin filled. Box material is solvent resistant and flame retardant according to UL94							
Related Documents	IEC 60384-2							
Rated Voltage V _R (VDC)	50	63	100	250	400	630		
Rated Voltage V _R (VAC)	30	40	63	160	200	220		
Capacitance Range (µF)	0.68 - 4.7	0.33 - 3.3	0.068 - 1.5	0.022 - 0.33	0.0068 - 0.15	0.001 - 0.047		
Capacitance Values	E6 series (IEC 60	063) measured at 1	kHz and +20 ±1°C			l		
Capacitance Tolerance	±5%, ±10%, ±20%							
Operating Temperature Range		-55°C to +105°C Upper operating temperature of +125°C is allowed for a maximum operating time of 1,000 hours. (Stacked technology only)						
Rated Temperature T _R	+85°C							
Voltage Derating	Above +85°C DC and AC voltage derating is 1.25%/°C							
Climatic Category	55/105/56 IEC 60068-1							
	Storage time: ≤ 2	4 months from the	date marked on the	label package				
	Average relative	humidity per year ≤	70%					
Storage Conditions	RH ≤ 85% for 30 (days randomly distr	ributed throughout t	the year				
	Dew is absent							
	Temperature: -4	0 to 80°C (see "Max	kimum Humidity in S	Storage Conditions'	" graph below)			
Test Voltage	1.6 x V _R VDC for 2	2 seconds (betwee	n terminations) at +:	25°C ±5°C				
Capacitance Drift	Maximum 3% aft to 60%	er a 2 year storage	period at a tempera	ture of +10°C to +4	0°C and a relative h	umidity of 40%		
	Operational life >	200,000 hours						
Reliability (Reference MIL-HDBK-217)		IT, T = +40°C, V = 0.	ĸ					
	Failure criteria: open or short circuit, capacitance change > 10%, DF 2 times the catalog limits, IR < 0.005 x initial limit							
Maximum Pulse Steepness	dV/dt according to Table 1. For peak to peak voltages lower than rated voltage (Vpp $\langle V_{R} \rangle$), the specified dv/dt can be multiplied by the factor V_{R}/Vpp							
Temperature Coefficient	+400 (±200)ppm	+400 (±200)ppm/°C at 1 kHz						
Self Inductance (Lead Length ~ 2 mm)	Approximately 8	nH. Maximum 1nH	per 1 mm lead and	capacitor length.				



Performance Characteristics cont'd

	Maximum Values at 25°C ±5°C					
Dissingtion Foster ton S	Frequency	Frequency For all Capacitance Values				
Dissipation Factor tanδ	1 kHz	1.00%				
	10 kHz	1.50%				
	Measured at +25°C ±5°C, according to IEC 60384–2					
	Minimum Values Between Terminals					
Insulation Resistance	Voltage Charge/Time	C ≤ 0.33 µF	C > 0.33 µF			
	50 VDC for V _R ≤ 100 VDC 1 minute	≥ 3,750 MΩ (≥ 50,000 MΩ)*	≥ 1,250 MΩ • μF (≥ 5,000 MΩ • μF)*			
	100 VDC for V _R > 100 VDC 1 minute	≥ 30,000 MΩ (≥50,000 MΩ)*				

* typical value

Maximum Humidity in Storage Conditions



Qualification

Automotive grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, please visit their website at www.aecouncil.com.



Maximum Voltage (V_{rms}) vs. Frequency (Sinusoidal Waveform/Th \leq 40°C)





Maximum Current (I_{rms}) vs. Frequency (Sinusoidal Waveform/Th \leq 40°C)







Environmental Test Data

Damp Heat, Steady State Test	Test Cor	nditions:	Performances
	Temperature: Relative humidity (RH): Test duration:	+40°C ±2°C 93% ±2% 56 days	Δ C/C ≤ 5%, Δ tanδ ≤ 0.005 at 1 kHz IR after test ≥ 50% of initial limit
Endurance Test	Test Conditions		Performances
	Temperature: Voltage applied: Test duration:	+105°C ±2°C 1.25 x V _c 2,000 hours	Δ C/C ≤ 5%, Δ tanδ ≤ 0.005 at 10 kHz for C ≤ 1μF Δ tanδ ≤ 0.003 at 1 kHz for C > 1μF IR after test ≥ 50% of initial limit
Resistance to Soldering Heat Test	Test Co	nditions	Performances
	Solder bath temperature: Dipping time (with heat screen):	260°C ±5°C 10 seconds ±1 second	Δ C/C ≤ 2%, Δ tanδ ≤ 0.005 at 10 kHz for C ≤ 1μF Δ tanδ ≤ 0.003 at 1 kHz for C > 1μF IR after test ≥ initial limit

Environmental Compliance

All KEMET MKT capacitors are RoHS compliant.



Table 1 – Ratings & Part Number Reference

VDC	VAC	Capacitance	Dime	nsions i	in mm	Lead	dV/dt	Maximum K _o	New KEMET	Legacy Part
VDC	VAC	Value (µF)	В	Н	L	Spacing	(V/µs)	(V²/µs) ਁ	Part Number	Number
50	30	0.68	3.0	8.0	10.0	7.5	100	10000	66CD3680(1)6A(2)	R66CD3680(1)6A(2)
50	30	1.0	3.0	8.0	10.0	7.5	100	10000	66CD4100(1)6A(2)	R66CD4100(1)6A(2)
50	30	1.5	4.0	9.0	10.0	7.5	100	10000	66CD4150(1)6A(2)	R66CD4150(1)6A(2)
50	30	2.2	5.0	10.5	10.0	7.5	100	10000	66CD4220(1)6A(2)	R66CD4220(1)6A(2)
50	30	4.7	6.0	12.0	10.5	7.5	100	10000	66CD4470(1)6A(2)	R66CD4470(1)6A(2)
63	40	0.33	3.0	8.0	10.0	7.5	120	15120	66DD3330(1)7A(2)	R66DD3330(1)7A(2)
63	40	0.47	3.0	8.0	10.0	7.5	120	15120	66DD3470(1)6A(2)	R66DD3470(1)6A(2)
63	40	0.68	4.0	9.0	10.0	7.5	120	15120	66DD3680(1)7A(2)	R66DD3680(1)7A(2)
63	40	1.0	4.0	9.0	10.0	7.5	120	15120	66DD4100(1)7A(2)	R66DD4100(1)7A(2)
63	40	1.5	5.0	10.5	10.0	7.5	120	15120	66DD4150(1)7A(2)	R66DD4150(1)7A(2)
63	40	2.2	6.0	12.0	10.5	7.5	120	15120	66DD4220(1)6A(2)	R66DD4220(1)6A(2)
63	40	3.3	6.0	12.0	10.5	7.5	120	15120	66DD4330(1)6A(2)	R66DD4330(1)6A(2)
100	63	0.068	3.0	8.0	10.0	7.5	150	30000	66ED2680(1)7A(2)	R66ED2680(1)7A(2)
100	63	0.10	3.0	8.0	10.0	7.5	150	30000	66ED3100(1)7A(2)	R66ED3100(1)7A(2)
100	63	0.15	3.0	8.0	10.0	7.5	150	30000	66ED3150(1)7A(2)	R66ED3150(1)7A(2)
100	63	0.22	3.0	8.0	10.0	7.5	150	30000	66ED3220(1)7A(2)	R66ED3220(1)7A(2)
100	63	0.33	4.0	9.0	10.0	7.5	150	30000	66ED3330(1)7A(2)	R66ED3330(1)7A(2)
100	63	0.47	4.0	9.0	10.0	7.5	150	30000	66ED3470(1)7A(2)	R66ED3470(1)7A(2)
100	63	0.68	4.0	9.0	10.0	7.5	150	30000	66ED3680(1)7A(2)	R66ED3680(1)7A(2)
100	63	1.0	5.0	10.5	10.0	7.5	150	30000	66ED4100(1)7A(2)	R66ED4100(1)7A(2)
100	63	1.5	6.0	12.0	10.5	7.5	150	30000	66ED4150(1)6A(2)	R66ED4150(1)6A(2)
250	160	0.022	3.0	8.0	10.0	7.5	200	100000	66ID2220(1)7A(2)	R66ID2220(1)7A(2)
250	160	0.033	3.0	8.0	10.0	7.5	200	100000	66ID2330(1)7A(2)	R66ID2330(1)7A(2)
250	160	0.047	3.0	8.0	10.0	7.5	200	100000	66ID2470(1)7A(2)	R66ID2470(1)7A(2)
250	160	0.068	3.0	8.0	10.0	7.5	200	100000	66ID2680(1)6A(2)	R66ID2680(1)6A(2)
250	160	0.10	4.0	9.0	10.0	7.5	200	100000	66ID3100(1)7A(2)	R66ID3100(1)7A(2)
250	160	0.15	4.0	9.0	10.0	7.5	200	100000	66ID3150(1)7A(2)	R66ID3150(1)7A(2)
250	160	0.22	5.0	10.5	10.0	7.5	200	100000	66ID3220(1)7A(2)	R66ID3220(1)7A(2)
250	160	0.33	6.0	12.0	10.5	7.5	200	100000	66ID3330(1)6A(2)	R66ID3330(1)6A(2)
400	200	0.0068	3.0	8.0	10.0	7.5	275	220000	66MD1680(1)7A(2)	R66MD1680(1)7A(2)
400	200	0.010	3.0	8.0	10.0	7.5	275	220000	66MD2100(1)7A(2)	R66MD2100(1)7A(2)
400	200	0.015	3.0	8.0	10.0	7.5	275	220000	66MD2150(1)7A(2)	R66MD2150(1)7A(2)
400	200	0.022	3.0	8.0	10.0	7.5	275	220000	66MD2220(1)6A(2)	R66MD2220(1)6A(2)
400	200	0.033	4.0	9.0	10.0	7.5	275	220000	66MD2330(1)7A(2)	R66MD2330(1)7A(2)
400	200	0.047	4.0	9.0	10.0	7.5	275	220000	66MD2470(1)7A(2)	R66MD2470(1)7A(2)
400	200	0.068	5.0	10.5	10.0	7.5	275	220000	66MD2680(1)7A(2)	R66MD2680(1)7A(2)
400	200	0.10	6.0	12.0	10.5	7.5	275	220000	66MD3100(1)6A(2)	R66MD3100(1)6A(2)
400	200	0.15	6.0	12.0	10.5	7.5	275	220000	66MD3150(1)6A(2)	R66MD3150(1)6A(2)
630	220	0.0010	3.0	8.0	10.0	7.5	40	50400	66PD1100(1)10(2)	R66PD1100(1)10(2)
630	220	0.0015	3.0	8.0	10.0	7.5	40	50400	66PD1150(1)10(2)	R66PD1150(1)10(2)
630	220	0.0022	3.0	8.0	10.0	7.5	40	50400	66PD1220(1)10(2)	R66PD1220(1)10(2)
630	220	0.0033	3.0	8.0	10.0	7.5	40	50400	66PD1330(1)10(2)	R66PD1330(1)10(2)
630	220	0.0047	3.0	8.0	10.0	7.5	40	50400	66PD1470(1)10(2)	R66PD1470(1)10(2)
630	220	0.0068	4.0	9.0	10.0	7.5	40	50400	66PD1680(1)10(2)	R66PD1680(1)10(2)
630	220	0.010	4.0	9.0	10.0	7.5	300	378000	66PD2100(1)7A(2)	R66PD2100(1)7A(2)
630	220	0.015	4.0	9.0	10.0	7.5	300	378000	66PD2150(1)7A(2)	R66PD2150(1)7A(2)
630	220	0.022	5.0	10.5	10.0	7.5	300	378000	66PD2220(1)7A(2)	R66PD2220(1)7A(2)
630	220	0.033	6.0	12.0	10.5	7.5	300	378000	66PD2330(1)6A(2)	R66PD2330(1)6A(2)
630	220	0.047	6.0	12.0	10.5	7.5	300	378000	66PD2470(1)6A(2)	R66PD2470(1)6A(2)
VDC	VAC	Capacitance Value (µF)	B (mm)	H (mm)	L (mm)	Lead Spacing	dV/dt (V/ µs)	Max K _o (V²/µs)	New KEMET Part Number	Legacy Part Number

(1) Insert lead and packaging code. See Ordering Options Table for available options.

Bold denotes wound capacitor technology

⁽²⁾ J = 5%, K = 10%, M = 20%



Soldering Process

The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as a primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result in degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles are recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

Manual Soldering Recommendations

The following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont'd

Wave Soldering Recommendations cont'd

1. The table indicates the maximum set-up temperature of the soldering process

Dielectric		imum Pre emperatu	Maximum Peak Soldering Temperature		
Film Material	Capacitor Pitch ≤ 10 mm	Capacitor Pitch = 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm
Polyester	130°C	130°C	130°C	270°C	270°C
Polypropylene	100°C	110°C	130°C	260°C	270°C
Paper	130°C	130°C	140°C	270°C	270°C
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C

2. The maximum temperature measured inside the capacitor:

Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, **however, instead of two baths, there is only one bath with a time from 3 to 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.



Marking

- KEMET logo
- Capacitance
- Capacitance tolerance
- Rated DC voltage

Packaging Quantities

Lead Spacing	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel 355 mm	Ammo Taped
	3.0	8.0	10.0	1,500	1,750	2,100	2,800
7.5	4.0	9.0	10.0	2,000	1,500	1,500	2,100
7.5	5.0	10.5	10.0	1,500	1,000	1,200	1,600
	6.0	12.0	10.5	1,000	800	1,000	1,350



Lead Taping & Packaging (IEC 60286-2)

Figure 1 – Lead Spacing 5 & 7.5 mm



Figure 2 – Lead Spacing 7.5 mm



			Dimensi	ons (mm)	
Description	Symbol	l			
Description	oyini sor	5	7.5	7.5	Tolerance
		Figure 1	Figure 1	Figure 2	
Lead wire diameter	d	0.5 - 0.6	0.5 - 0.6	0.5 - 0.6	±0.05
Taping lead space	Р	12.7	12.7	12.7	±1
Feed hole lead space	P ₀	12.7	12.7	12.7	±0.2*
Centering of the lead wire	P ₁	3.85	2.6	3.75	±0.7
Centering of the body	P ₂	6.35	6.35		±1.3
Lead spacing	F	5	7.5	7.5	+0.6 -0.1
Component alignment	Δh	0	0	0	±2
Height of component from tape center	H ₀ **	18.5	18.5	18.5	±0.5
Carrier tape width	W	18	18	18	+1 -0.5
Hold down tape width	W _o	6	6	6	Minimum
Hole position	W ₁	9	9	9	±0.5
Hold down tape position	W ₂	3	3	3	Maximum
Feed hole diameter	D ₀	4	4	4	±0.2
Tape thickness	t	0.7	0.7	0.7	±0.2

*Maximum 1 mm on 20 lead spaces.

** H_0 = 16.5 mm is available upon request.

For orders of capacitors with lead space = 7.5 mm, please specify the

requested version (Figure 1 or Figure 2).



Ammo Specifications

Dimensions in mm							
H W T							
360 * 340 59							

* Lower dimension available upon request (maximum 295 mm)



Reel Specifications

Dimensions in mm		
D	Н	W
355	30	55 maximum







KEMET Electronics Corporation Sales Offices

For a complete list of our global sales offices, please visit www.kemet.com/sales.

Disclaimer

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed.

All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.

KEMET is a registered trademark of KEMET Electronics Corporation.